# Old Company Name in Catalogs and Other Documents

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# RENESAS

# HD74AC538 1-of-8 Decoder with 3-State Output

REJ03D0276–0200Z (Previous ADE-205-397 (Z)) Rev.2.00 Jul.16.2004

# Description

The HD74AC538 decoder/demultiplexer accepts three Address (A0 to A2) input signal and decodes them to select one of eight mutually exclusive outputs. A polarity control input (P) determines whether the outputs are active LOW or active HIGH. A HIGH signal on either of the active LOW output Enable  $\overline{(OE)}$  inputs forces all outputs to the high impedance state. Two active HIGH and two active LOW input enables are available for easy expansion to 1-of-32 decoding with four packages, or for data demultiplexing to 1-of-8 or 1-of-16 destinations.

## Features

- Output Polarity Control
- Data Demultiplexing Capability
- Multiple Enables for Expansion
- Outputs Source/Sink 24 mA
- Ordering Information

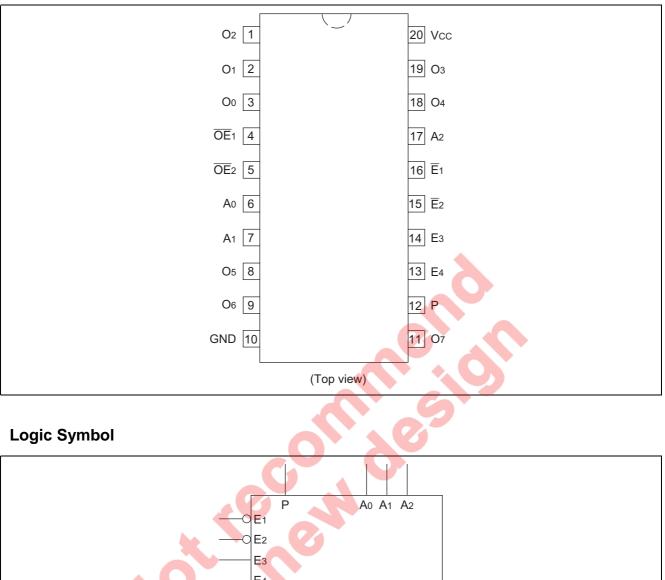
Part Name	Package Type	Package Code	Package Abbrev	iation Taping Abbreviation (Quantity)
HD74AC538FPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)
HD74AC538RPEL	SOP-20 pin (JEDEC)	FP-20DBV	RP	EL (1,000 pcs/reel)

Notes: 1. Please consult the sales office for the above package availability.

2. The packages with lead-free pins are distinguished from the conventional products by adding V at the end of the package code.



# **Pin Arrangement**

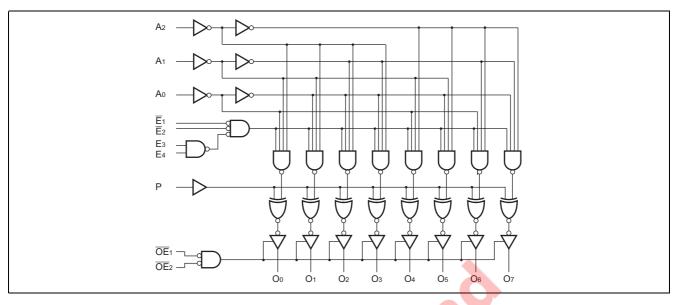


# E3 E4 O OE1 OE2 O0 O1 O2 O3 O4 O5 O6 O7

# **Pin Names**

$A_0$ to $A_2$	Address Inputs
$\overline{\mathrm{E}}_{1}, \overline{\mathrm{E}}_{2}$	Enable Inputs (Active LOW)
E <sub>3</sub> , E <sub>4</sub>	Enable Inputs (Active HIGH)
Р	Polarity Control Input
$\overline{OE}_1, \overline{OE}_2$	Output Enable Inputs (Active LOW)
$O_0$ to $O_7$	3-State Outputs

# Logic Diagram



# **Truth Table**

Truth Table																	
				I	nput	s							Ou	tputs			
Function	$\overline{OE}_1$	$\overline{OE}_2$	<b>E</b> <sub>1</sub>	$\overline{E}_2$	$E_3$	$E_4$	<b>A</b> <sub>2</sub>	<b>A</b> <sub>1</sub>	A <sub>0</sub>	O <sub>0</sub>	01	02	03	<b>O</b> <sub>4</sub>	<b>O</b> <sub>5</sub>	<b>O</b> <sub>6</sub>	<b>O</b> <sub>7</sub>
High impedance	Н	Х	Х	Х	Х	Х	Х	Х	Х	Х	Z	Z	Ζ	Z	Z	Z	Z
	Z	Н	Х	Х	Х	Х	X	X	X	Z	z	Z	Z	Z	Z	Z	Z
Disable	L	L	Н	Х	Х	Х	X	X	X	Outp	outs eq	ual inp	out				
	L	L	Х	Н	Х	X	X	X	X								
	L	L	Х	Х	L	X	X	Х	X								
	L	L	Х	Х	X	L	Х	Х	X								
Active HIGH output	L	L	L	Ļ	н	Н	L	F/	L	Н	L	L	L	L	L	L	L
(P = L)	L	L	L 💧	Ľ	Н	Н		L	н	L	Н	L	L	L	L	L	L
	L	L	L	L	Н	H	L.	Н	L	L	L	Н	L	L	L	L	L
	L	L	L	L	Н	Н	L	Н	Н	L	L	L	Н	L	L	L	L
	L	L		L	H	H	Н	L	L	L	L	L	L	Н	L	L	L
	4	L	L	L	Н	Н	Н	L	Н	L	L	L	L	L	Н	L	L
	L	L	L	L	Н	Н	Н	Н	L	L	L	L	L	L	L	Н	L
	L	L.	L	L	Н	Н	Н	Н	Н	L	L	L	L	L	L	L	Н
Active LOW output	L	L	L	L	Н	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
(P = L)	L	L	L,	L	Н	Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н
	L	L	L	L	Н	Н	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н
	L	L	L	L	Н	Н	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н
	L	L	L	L	Н	Н	Н	L	L	Н	Н	Н	Н	L	Н	Н	Н
	L	L	L	L	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н
	L	L	L	L	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н
	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

High Voltage Level Н:

Low Voltage Level L :

X : Immaterial

Z : High Impedance

### **Absolute Maximum Ratings**

ltem	Symbol	Ratings	Unit	Condition
Supply voltage	V <sub>cc</sub>	–0.5 to 7	V	
DC input diode current	I <sub>IK</sub>	-20	mA	$V_{I} = -0.5V$
		20	mA	$V_{I} = Vcc+0.5V$
DC input voltage	V	-0.5 to Vcc+0.5	V	
DC output diode current	Ι <sub>οκ</sub>	-50	mA	$V_0 = -0.5V$
		50	mA	$V_0 = Vcc+0.5V$
DC output voltage	Vo	-0.5 to Vcc+0.5	V	
DC output source or sink current	I <sub>o</sub>	±50	mA	
DC $V_{cc}$ or ground current per output pin	I <sub>CC</sub> , I <sub>GND</sub>	±50	mA	
Storage temperature	Tstg	-65 to +150	°C	

# **Recommended Operating Conditions**

	Symbol	Ratings	Unit	Condition
Supply voltage	V <sub>cc</sub>	2 to 6	V	
Input and Output voltage	V <sub>I</sub> , V <sub>O</sub>	0 to V <sub>cc</sub>	V	
Operating temperature	Та	-40 to +85	°C	
Input rise and fall time	tr, tf	8	ns/V	$V_{\rm CC} = 3.0 V$
(except Schmitt inputs)				V <sub>cc</sub> = 4.5 V
$V_{IN}$ 30% to 70% $V_{CC}$				V <sub>cc</sub> = 5.5 V
	200	N 20.		



# **DC Characteristics**

ltem	Sym- bol	Vcc (V)	7	Га = 25°(	C	Ta = -40 to +85°C		Unit	Condition		
			min.	typ.	max.	min.	max.				
Input Voltage	V <sub>IH</sub>	3.0	2.1	1.5	—	2.1	—	V	$V_{OUT}$ = 0.1 V or $V_{CC}$ –0.1 V		
		4.5	3.15	2.25	—	3.15	—				
		5.5	3.85	2.75	—	3.85	—				
	V <sub>IL</sub>	3.0	—	1.50	0.9	—	0.9		$V_{OUT} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$		
		4.5	—	2.25	1.35	—	1.35				
		5.5	—	2.75	1.65	—	1.65				
Output voltage	V <sub>OH</sub>	3.0	2.9	2.99	—	2.9	—	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$		
		4.5	4.4	4.49	—	4.4	—		$I_{OUT} = -50 \ \mu A$		
		5.5	5.4	5.49	—	5.4	—				
		3.0	2.58	_	—	2.48	—		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} = -12 \text{ mA}$		
		4.5	3.94	—	—	3.80	—		I <sub>он</sub> = –24 mА		
		5.5	4.94	_	—	4.80	—		I <sub>он</sub> = –24 mA		
	V <sub>OL</sub>	3.0	—	0.002	0.1	—	0.1		$V_{IN} = V_{IL} \text{ or } V_{IH}$		
		4.5	—	0.001	0.1	_	0.1		I <sub>OUT</sub> = 50 μA		
		5.5	—	0.001	0.1	—	0.1 🧲				
		3.0	—	—	0.32	_	0.37		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OL} = 12 \text{ mA}$		
		4.5	—	—	0.32	—	0.37		I <sub>OL</sub> = 24 mA		
		5.5	—	—	0.32		0.37		I <sub>OL</sub> = 24 mA		
Input leakage current	I <sub>IN</sub>	5.5	_	—	±0.1		±1.0	μA	$V_{IN} = V_{CC}$ or GND		
3 State current	I <sub>oz</sub>	5.5	_	_	±0.5	-	±5.0	μA	$V_{IN(OE)} = V_{IL}, V_{IH}$		
									$V_{IN} = V_{CC}$ or GND		
									$V_{OUT} = V_{CC} \text{ or } GND$		
Dynamic output	I <sub>OLD</sub>	5.5	—			86	<u> </u>	mA	V <sub>OLD</sub> = 1.1 V		
current*	I <sub>OHD</sub>	5.5	-		-	-75	—	mA	V <sub>OHD</sub> = 3.85 V		
Quiescent supply current	I <sub>cc</sub>	5.5	Z	-	8.0	-	80	μA	$V_{IN} = V_{CC}$ or ground		

\*Maximum test duration 2.0 ms, one output loaded at a time.

200



# **AC Characteristics**

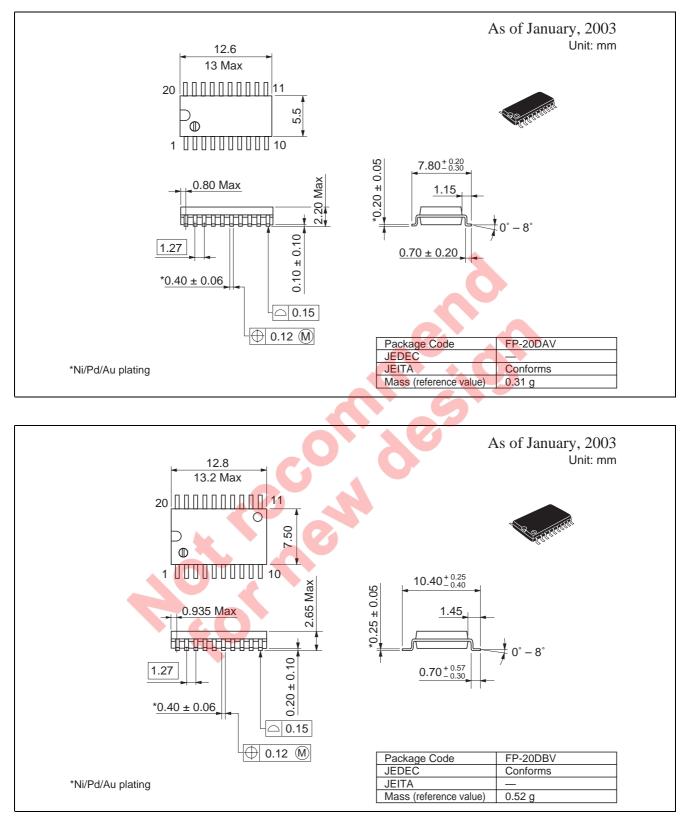
				Γa = +25°			C to +85°C		
ltem	Symbol	V <sub>cc</sub> (V)* <sup>1</sup>	Min	С <sub>∟</sub> = 50 р   Тур	Max	C <sub>L</sub> =	50 pF Max	Unit	
Propagation delay	t <sub>PLH</sub>	3.3	1.0	10.5	17.5	1.0	20.0	ns	
$A_n$ to $O_n$	PLH	5.0	1.0	8.0	12.5	1.0	14.0		
Propagation delay	t <sub>PHL</sub>	3.3	1.0	9.5	17.5	1.0	20.0	ns	
$A_n$ to $O_n$	TEUL	5.0	1.0	7.0	12.0	1.0	14.0		
Propagation delay	t <sub>PLH</sub>	3.3	1.0	11.0	19.5	1.0	23.0	ns	
$\overline{E}_1$ , or $\overline{E}_2$ to $O_n$	PLA	5.0	1.0	8.0	14.5	1.0	16.5		
Propagation delay	t <sub>PHL</sub>	3.3	1.0	10.0	19.5	1.0	23.0	ns	
$\overline{E}_1$ , or $\overline{E}_2$ to $O_n$	FIL	5.0	1.0	8.0	14.5	1.0	16.5		
Propagation delay	t <sub>PLH</sub>	3.3	1.0	11.0	19.5	1.0	23.0	ns	
$\overline{E}_3$ , or $\overline{E}_4$ to $O_n$		5.0	1.0	8.5	14.5	1.0	17.0		
Propagation delay	t <sub>PHL</sub>	3.3	1.0	10.5	20.0	1.0	23.5	ns	
$\overline{E}_3$ , or $\overline{E}_4$ to $O_n$		5.0	1.0	8.0	15.0	1.0	18.0		
Propagation delay	t <sub>PLH</sub>	3.3	1.0	10.5	15.5	1.0	17.5	ns	
P to O <sub>n</sub>		5.0	1.0	9.0	11.0	1.0	12.5		
Propagation delay	t <sub>PHL</sub>	3.3	1.0	9.0	15.0	1.0	17.0	ns	
P to O <sub>n</sub>		5.0	1.0	7.5	10.5	1.0	11.5		
Propagation delay	t <sub>PZH</sub>	3.3	1.0	7.0	14.0	1.0	15.5	ns	
$\overline{OE}_n$ to $O_n$		5.0	1.0	5.0	8.5	1.0	9.5		
Propagation delay	t <sub>PZL</sub>	3.3	1.0	8.5	16.5	1.0	19.0	ns	
$\overline{OE}_n$ to $O_n$		5.0	1.0	5.5	9.5	1.0	11.5	1	
Propagation delay	t <sub>PHZ</sub>	3.3	1.0	7.0	14.0	1.0	15.5	ns	
$\overline{OE}_n$ to $O_n$		5.0	1.0	6.0	10.5	1.0	11.5	1	
Propagation delay	t <sub>PLZ</sub>	3.3	1.0	9.0	14.5	1.0	17.0	ns	
$\overline{OE}_n$ to $O_n$		5.0	1.0	7.0	10.5	1.0	12.0	1	

Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V Voltage Range 5.0 is 5.0 V  $\pm$  0.5 V

# Capacitance

ltem 🧹	Symbol	Тур	Unit	Condition
Input capacitance	CIN	4.5	pF	$V_{\rm CC} = 5.5 \text{ V}$
Power dissipation capacitance	C <sub>PD</sub>	100	pF	$V_{CC} = 5.0 V$

## **Package Dimensions**





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